

High Precision Current Limit Power Switch

Product Specification

DESCRIPTION

The GLF2310, GLF2311, GLF2313 and GLF2321 are an advanced technology fully integrated power switch for applications required for precision output current limiting. The GLF2310, GLF2311, GLF2313 and GLF2321 feature also various protection functions such as under voltage lockout, reverse current blocking (RCB), short circuit protection, and thermal shutdown.

The GLF2310, GLF2311, GLF2313 and GLF2321 provide a built-in output voltage slew rate control to limit the inrush current and voltage surges. The FLGB output pin can be used to send a signal of fault events to the system controller. The integrated thermal shutdown (TSD) insures complete protection for the switch during output current limit and short circuit conditions. The GLF2310, GLF2311, GLF2313 and GLF2321 are an ideal switch for USB power supply.

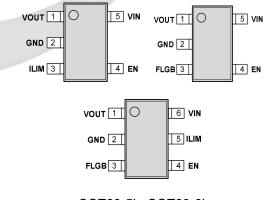
FEATURES

- Input Range: 2.5 V to 5.5 V
- Programmable Output Constant Current Limit:
- GLF2310A, GLF2311A
 - o Range: 40 mA to 2.1 A
- Fixed Output Constant Current Limit:
 - o GLF2311B, GLF2313B: 2.0 A Min
 - o GLF2321B: 1.5 A Min
- Low R_{ON} : 56 m Ω Typ. at 5.0 V_{IN}
- Ultra-Low I_Q: 20 μA Typ. at 5.0 V_{IN}
- \bullet Ultra-Low I_{SD}: 50 nA Typ. at 5.0 V_{IN}
- Under Voltage Lockout Protection
- Output Voltage Slew Rate Controlled
- Reverse Current Blocking Protection
- Short Circuit Protection
- Deglitched Fault Flag Indication
- Integrated Output Discharge Switch
 - o GLF2311x, GLF2313x, GLF2321x
- Thermal Shutdown Protection
- IEC 62368-1: 2018 CB Certification No. FI-52066

APPLICATIONS

- USB ports
- Notebooks
- Set-Top Boxes
- Telecom Systems

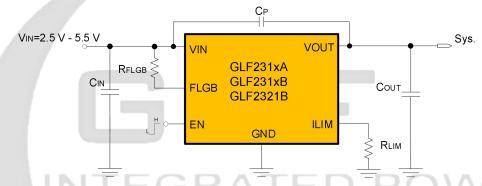
PACKAGE



DEVICE ORDERING INFORMATION

Part Number	Top Mark	Output Current Limit, I _{LIM}	Output Discharge	Fault Flag FLGB	EN Activity	Package
GLF2310A-T1G7	FA		NA	NA		SOT23-5L
GLF2311A-T1G7	FB	Programmable	300 Ω	NA	High	SOT23-5L
GLF2310A-T2G7	HA	Up to 2.1 A	NA	Yes		SOT23-6L
GLF2311A-T2G7	НВ		300 Ω	Yes		SOT23-6L
GLF2311B-T1G7	GB	Fixed 2.0 A Min	300 Ω	Yes		SOT23-5L
GLF2313B-T1G7	KD	Fixed 2.0 A Min	300 Ω	Yes	Low	SOT23-5L
GLF2321B-T1G7	KB	Fixed 1.5 A Min	300 Ω	Yes	High	SOT23-5L

APPLICATION DIAGRAM



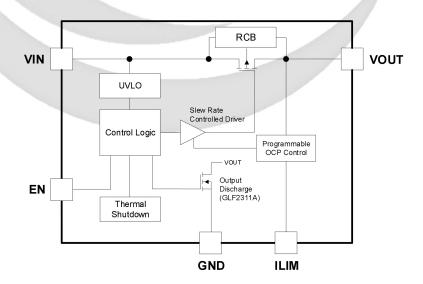
Notes: 1) ILIM pin for GLF231xA Only, and $R_{LIM} \ge 1.3 \text{ k}\Omega$

2) Cp = 1 µF is recommended to mitigate electrical noises when load current changes abruptly.

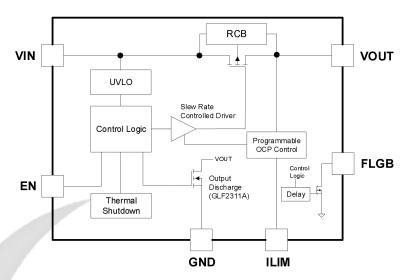
Figure 1. Typical Application

FUNCTIONAL BLOCK DIAGRAM

GLF2310A-T1G7, GLF2311A-T1G7



GLF2310A-T2G7, GLF2311A-T2G7



GLF2311B-T1G7, GLF2313B-T1G7, GLF2321B-T1G7

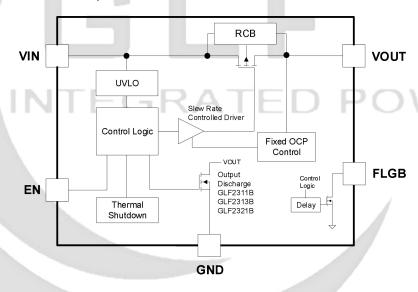
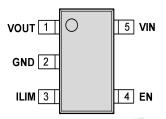


Figure 2. Functional Block Diagram

PIN CONFIGURATION

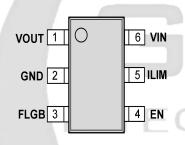
PIN DEFINITION

GLF2310A-T1G7, GLF2311A-T1G7



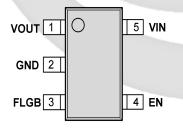
Pin#	Name	Description
1	VOUT	Switch output
2	GND	Ground
3	ILIM	Programmable current limit. Do not leave this pin floating.
4	EN	Active high switch output enables to control the switch
5	VIN	Switch Input. Supply voltage for IC

GLF2310A-T2G7, GLF2311A-T2G7



Pin #	Name	Description
1	VOUT	Switch output
2	GND	Ground
3	FLGB	Flag pin goes low to indicate OCP, SCP, RCB, UVLO and TSD fault conditions
4	EN	Active high switch output enables to control the switch
5	ILIM	Programmable current limit Do not leave this pin floating.
6	VIN	Switch Input. Supply voltage for IC

GLF2311B-T1G7, GLF2313B-T1G7 GLF2321B-T1G7



Pin#	Name	Description				
1	VOUT	Switch Output				
2	GND	Ground				
3	Flag pin goes low to indicate OCP, SCP, RCB, UVLO and TSD fault conditions					
4	EN	Active high switch output enables to control the switch Active low: GLF2313B				
5	VIN	Switch Input. Supply voltage for IC				

Figure 3. Package and Pin configuration

High Precision Current Limit Power Switch

ABSOLUTE MAXIMUM RATINGS

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Pa	Min.	Max.	Unit			
$V_{\text{IN}},V_{\text{OUT}},V_{\text{EN}}$	V _{IN} , V _{OUT} , V _{EN} to GND	/ _{IN} , V _{OUT} , V _{EN} to GND					
T _{STG}	Storage Junction Temperature	torage Junction Temperature					
TA	Operating Temperature Range		- 40	85	°C		
θЈА	Thermal Resistance, Junction to Amb	Thermal Resistance, Junction to Ambient					
ESD	Electrostatic Discharge Capability	Human Body Model, JESD22-A114	± 8		kV		
ESD	Electrostatic Discharge Capability	± 2		ΚV			

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min.	Max.	Unit
V _{IN}	Supply Voltage	2.5	5.5	V
T _A	Ambient Operating Temperature	- 40	85	°C

ELECTRICAL CHARACTERISTICS

Values are at V_{IN} = 5.0 V and T_A = 25 °C. Unless otherwise noted

Symbol	Parameter	Conditions		Min.	Тур.	Max.	Units
Basic Oper	ation						
lq	Quiescent Current	V _{EN} = Enable, I _{OUT} = 0 mA			20	30	μA
I _{SD}	Shutdown Current	V _{EN} = Disable, I _{OUT} = 0 mA			50	100	nA
		V _{IN} = 5.0 V. Iou _T = 500 mA	T _A = 25 °C		56	70	
В	On-Resistance	VIN- 5.0 V, 1001- 500 IIIA	T _A = 85 °C ⁽¹⁾		64		mΩ
R _{on}	On-Resistance	V 22 V I 500 m A	T _A = 25 °C		64	80	11112
		V _{IN} =3.3 V, I _{OUT} = 500 mA	T _A = 85 °C ⁽¹⁾		74		
R _{DSC}	Output Discharge Resistance	V _{EN} = Low , I _{FORCE} = 10 mA GLF2311x, GLF2313x, GL	F2321x		300		Ω
V _{IH}	EN Input Logic High Voltage	V _{IN} = 2.5 V to 5.5 V		1.2			V
V _{IL}	EN Input Logic Low Voltage	V _{IN} = 2.5 V to 5.5 V				0.6	V
R _{EN}	EN pull down resistance	Internal Resistance			10	13	ΜΩ
R _{EN}	EN pull up resistance	Internal Resistance, GLF2	313B only		10	13	ΜΩ
I _{EN}	EN Source or Sink Current	V _{EN} = 5.5 V				0.6	μA
V _{FLGB}	FLGB Output Low Voltage	I _{FLGB} = 0.5 mA				180	mV
I _{FLGB}	FLGB Output High Leakage	V _{FLGB} = 5.5 V			6		nA
		Delay time for assertion at over current			8		ms
t _{FLGB}	FLGB Output Delay Time (1)	Delay time for assertion at thermal shutdown condition			100		μs

Values are at V_{IN} = 5.0 V and T_A = 25°C. Unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Protection					•	
V_{UVLO}	Under Voltage Lockout Voltage	Input Rising		2.3		V
VUVLO	Onder Voltage Lockout Voltage	Input Falling		2.2		V
		R _{LIM} = 1.3 kΩ, GLF231xA ⁽¹⁾	2.0	2.1	2.2	
I _{LIM}	Over Current Limit	GLF231xB	2.0	2.2	2.4	Α
		GLF2321B	1.5	1.8	2.0	
		R _{LIM} = 1.3 kΩ, GLF231xA		6.6		
I _{SC}	Short Circuit Current Detection (1)	GLF231xB		6.6		Α
		GLF2321B		5.3		
toc	Over Current Limit Protection Delay Time (1)	R_{LIM} = 1.3 kΩ, R_{OUT} = 2 Ω		84		μs
t _{sc}	Short Circuit Protection Delay Time (1)	R_{LIM} = 1.3 kΩ, R_{OUT} = 0.2 Ω		8		μs
.,	Reverse Current Blocking Protection Trip Voltage	V _{OUT} - V _{IN}	20	40	105	>/
V_{RCB}	Reverse Current Blocking Protection Release Voltage	V _{IN} - V _{OUT}	12	25	80	- mV
I _{RCB}	Reverse Current Blocking Protection Leakage	(V _{OUT} - V _{IN}) > V _{RCB}			1	μA
TSD	Thermal Shutdown Threshold			140		°C
Hyst	Thermal Shutdown Release Hysteresis	GRATED PO	\mathcal{I}	20	EK	°C
Switching C	Characteristics (2)					
t _{dON}	Turn-On Delay	5 45000 40 5		160		
t _R	V _{OUT} Rise Time	R _{OUT} = 150 Ω, C _{OUT} =1.0 μF		600		
t _{dOFF}	Turn-Off Delay	R _{OUT} =150 Ω, C _{OUT} =1.0 μF	1	15		
t _F	V _{OUT} Fall Time	GLF2310x		270		μs
t _{dOFF}	Turn-Off Delay	R _{OUT} =150 Ω, C _{OUT} =1.0 μF		15		
t _F	V _{OUT} Fall Time	GLF2311x, GLF2313B, GLF2321B		200		

Notes: 1. By design; characterized; not production tested.

2. Switching Timing Diagram

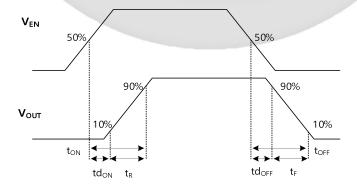
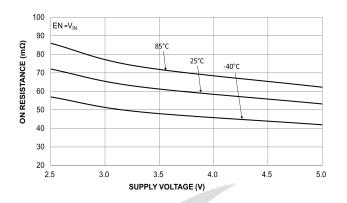


Figure 4. Switching Timing Diagram

TYPICAL PERFORMANCE CHARACTERISTICS



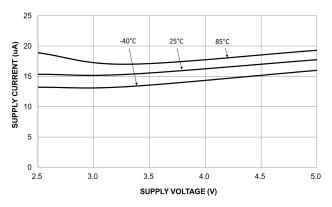
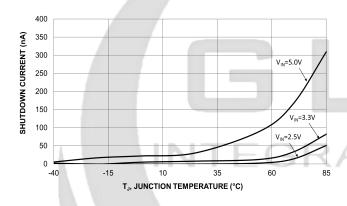


Figure 5. On-Resistance vs. Supply Voltage

Figure 6. Quiescent Current vs. Supply Voltage



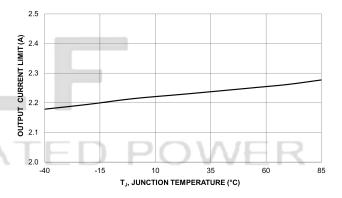
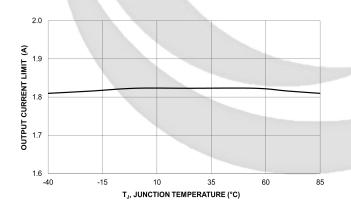


Figure 7. Shutdown Current vs. Temperature

Figure 8. Over Current Limit vs. Temperature, GLF231xB



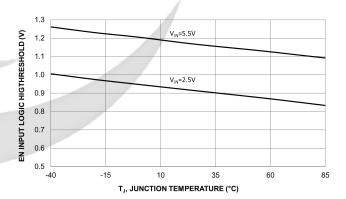


Figure 9. Over Current Limit vs. Temperature, GLF2321B

Figure 10. EN Input Logic High Threshold

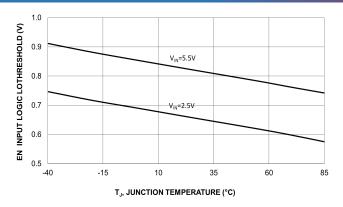
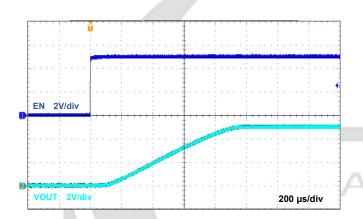


Figure 11. EN Input Logic Low Threshold



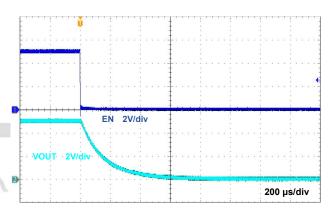


Figure 12. Turn-On Response $V_{IN}\text{=}5.0~V,~C_{IN}\text{=}1.0~\mu\text{F},~C_{OUT}\text{=}1.0~\mu\text{F},~R_{L}\text{=}150~\Omega$

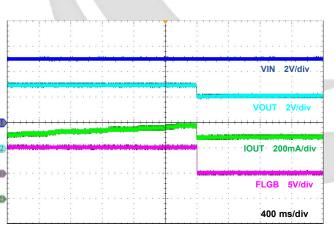


Figure 13. Turn-Off Response $V_{\text{IN}}\text{=}5.0 \text{ V, } C_{\text{IN}}\text{=}1.0 \text{ } \mu\text{F, } C_{\text{OUT}}\text{=}1.0 \text{ } \mu\text{F, } R_{\text{L}}\text{=}150 \text{ } \Omega$

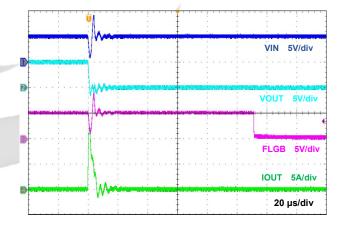


Figure 14. Current Limit Response, GLF231xA $V_{\text{IN}}{=}5.0$ V, $C_{\text{IN}}{=}1.0$ µF, $C_{\text{OUT}}{=}1.0$ µF, $R_{\text{LIM}}{=}5$ k Ω

Figure 15. Short Circuit Response $V_{IN}\text{=}5.0~V,~C_{IN}\text{=}1.0~\mu\text{F},~C_{OUT}\text{=}1.0~\mu\text{F},~R_{LIM}\text{=}5~k\Omega,~R_{L}\text{=}0~\Omega$

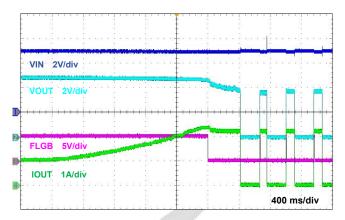


Figure 16. Current Limit Response, GLF231xB V_{IN} =5.0 V, C_{IN} =1.0 μF , C_{OUT} =1.0 μF

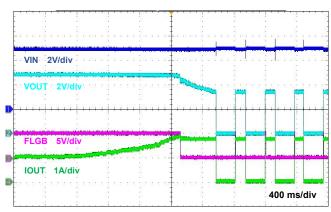


Figure 17. Current Limit Response, GLF2321B V_{IN} =5.0 V, C_{IN} =1.0 μF , C_{OUT} =1.0 μF

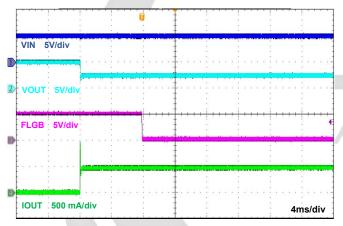


Figure 18. FLGB Response with OCP V_{IN} =5.0 V, C_{IN} =1.0 μ F, C_{OUT} =1.0 μ F

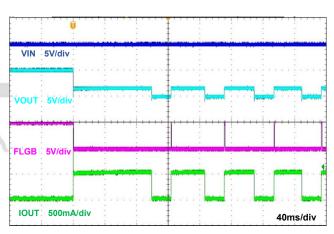


Figure 19. Thermal Shutdown Response V_{IN} =5.0 V, C_{IN} =1.0 μ F, C_{OUT} =1.0 μ F

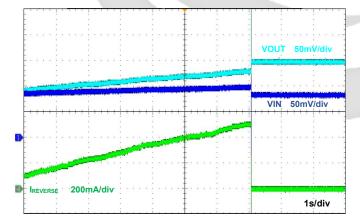


Figure 20. Reverse Current Blocking Threshold $V_{\text{IN}}{=}3.3$ V, $V_{\text{OUT}}{=}\text{Up}$ to 3.4 V, $C_{\text{IN}}{=}1.0$ µF, $C_{\text{OUT}}{=}1.0$ µF

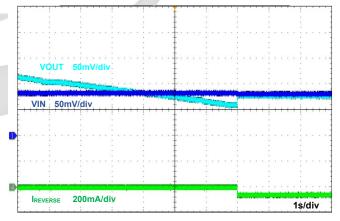


Figure 21. Reverse Current Blocking Release V_{IN} =3.3 V, V_{OUT} = Down to 3.2 V, C_{IN} =1.0 μ F, C_{OUT} =1.0 μ F



High Precision Current Limit Power Switch

APPLICATION INFORMATION

The GLF2310, GLF2313 and GLF2321 are an advanced technology fully integrated power switch for applications required for precision output current limiting. It features also various protection functions such as under voltage lockout, reverse current blocking (RCB), short circuit protection, and thermal shutdown.

Input and Output Capacitor

A minimum 1 μ F input capacitor is recommended to be placed close to the VIN pin to reduce the voltage drop on the input power rail caused by transient inrush current at start-up. A higher input capacitor value can be used to further attenuate the input voltage drop. Also, a minimum 1 μ F output capacitor is recommended to minimize voltage undershoot on the output pin during the transition when the switch is turned off. Undershoot can be caused by parasitic inductance from board traces or intentional load inductances. If load inductances do exist, use of an output capacitor can improve output voltage stability and system reliability. The COUT capacitor should be placed close to the VOUT and GND pins.

EN Pin

The GLF2310, GLF2311, and GLF2321 can be activated by EN pin high and the GLF2313 can be enabled by low. Note that the EN pin has an internal pull-down or pull-up resistor to maintain a reliable status without EN signal applied from an external controller.

Reverse Current Blocking

The GLF2310, GLF2313 and GLF2321 have a built-in reverse current blocking protection which always monitors the output voltage level regardless of the status of EN pin to check if it is greater than the input voltage. When the output voltage goes beyond the input voltage by 40 mV, that is the reverse current blocking protection trip voltage, the reverse current blocking function block turns off the switch. Note that some reverse current can occur until the V_{RCB} is triggered. The main switch will resume normal operation when the output voltage drops below the input source by the reverse current blocking protection release voltage.

Fault Flag Response

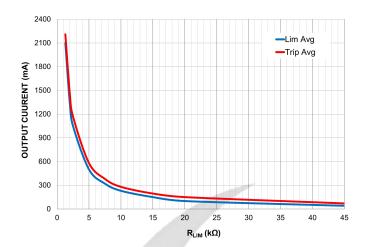
The output of the open drain FLGB pin goes active low for any of following fault conditions: output current limit, output short-circuit, Input undervoltage, reverse current blocking, or thermal shutdown. It is designed to avoid false FLGB reporting by using an internal 8 ms deglitch delay for the current limit condition and 100 µs delay for the short circuit and over temperature conditions. The FLGB output remains low until over-current or over-temperature condition is removed. When short circuit fault conditions occur, the device is latched-off and the FLGB output remains low. The FLGB signal is de-asserted once device power is cycled or the enable is toggled and the device resumes normal operation.

Current Limiting and Short Circuit Protection

When the GLF231x and GLF2321 are enabled, the current-limit circuitry starts monitoring the output current. When the load current reaches up to the over current protection threshold, the device clamps the output current to a constant current limit level. The preset constant current limits of GLF231xB and GLF2321B are 2.0 A and 1.5 A respectively. A constant output current limit level of GLF231xA can be programmed by an external resistor ($R_{LIM} \ge 1.3$ k Ω) between ILIM and GND. The 1% precision resistors are recommended. The R_{LIM} resistor traces should be as short as possible to reduce parasitic effects on the current-limit accuracy. Refer to the table 1 and Figure 21 to find the resistor values corresponding to different current limit levels. The thermal shutdown protection (TSD) turns off the device when the junction temperature exceeds 140 °C at the current limit condition. As the junction temperature cools down to 120 °C, the device is turned on again. The short circuit protection will take action immediately to shut down the device once a short circuit on the output node is detected. The device remains off until power is cycled or the EN pin is toggled.



Current Limiting and Short Circuit Protection (continued)



R _{LIM}		ent Limit Typ (mA)	•	Current Limit Typ (mA)		
(kΩ)	Min	Тур	Max	Min	Тур	Max
1.3	2100	2210	2300	2000	2100	2200
2.0	1350	1460	1550	1250	1340	1450
2.5	1100	1170	1250	1000	1050	1100
5.0	500	580	650	450	500	550
7.5	350	380	410	300	320	340
10	250	280	80 320 200	200 230	230	260
15	165	195	225	120	150	170
20	130	150	170	80	100	120
45	50	70	90	15	40	60

Figure 22. Current Trip and Limit vs. RLIM

 $\label{eq:Note:TA} Note: T_A = 25 \ ^{\circ}C$ Table 1. Current Limit Level by R_{LIM}

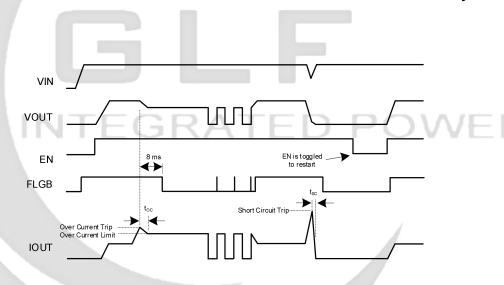


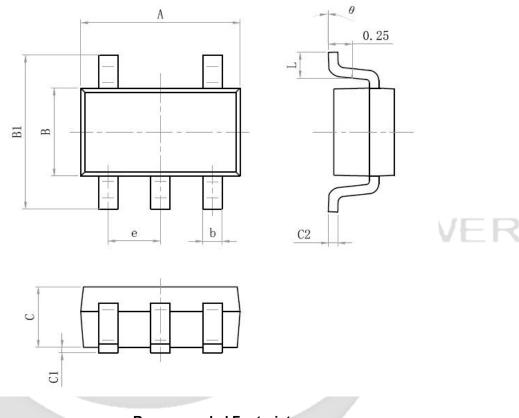
Figure 23. Over Current and Short Circuit Protection



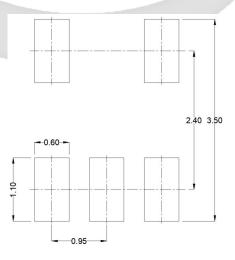
PACKAGE OUTLINE

SOT23-5L

Size Mark	Min(mm)	Max(mm)	Size Mark	Min(mm)	Max(mm)
A	2.82	3.02	С	1.05	1.15
е	0.9	95 (BSC)	C1	0.03	0.15
b	0.28	0.45	C2	0.12	0.23
В	1.50	1.70	L	0.35	0.55
B1	2.60	3.00	θ	0°	8°



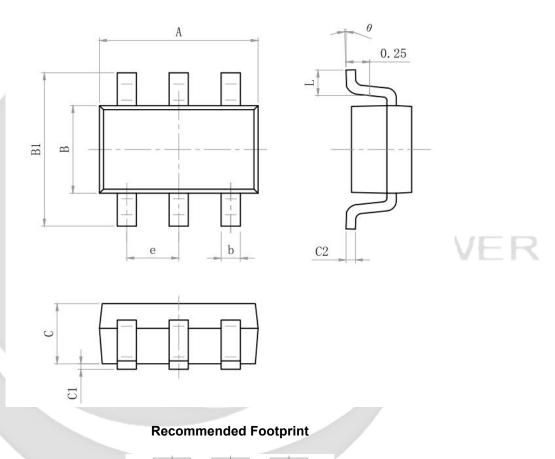
Recommended Footprint

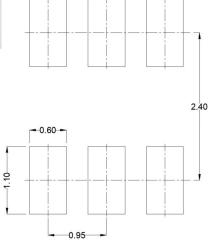




SOT23-6L

Size Mark	Min(mm)	Max(mm)	Size Mark	Min(mm)	Max(mm)
A	2.82	3. 02	C	1.05	1. 15
e	0.9	95 (BSC)	C1	0.03	0. 15
b	0. 28	0.45	C2	0.12	0. 23
В	1.50	1.70	L	0.35	0. 55
B1	2, 60	3, 00	θ	0°	8°

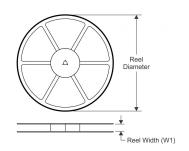


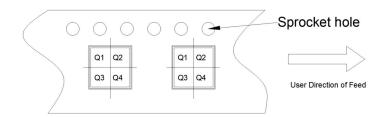


TAPE AND REEL INFORMATION

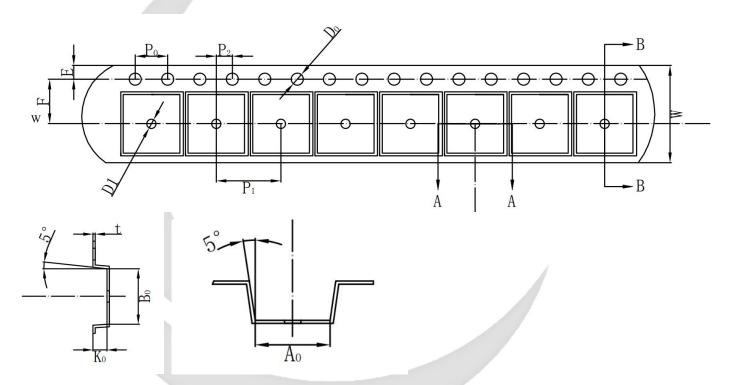
REEL DIMENSIONS

QUADRANT ASSIGNMENTS PIN 1 ORIENTATION TAPE





TAPE DIMENSIONS



Device	Package	Pins	SPQ	Reel Diameter(mm)	Reel Width W1	Α0	В0	K0	P1	w	Pin1
GLF2310A-T1G7	SOT23-5	5	3000	178	9	3.25	3.30	1.38	4	8	Q3
GLF2311A-T1G7	SOT23-5	5	3000	178	9	3.25	3.30	1.38	4	8	Q3
GLF2310A-T2G7	SOT23-6	6	3000	178	9	3.25	3.30	1.38	4	8	Q3
GLF2311A-T2G7	SOT23-6	6	3000	178	9	3.25	3.30	1.38	4	8	Q3
GLF2311B-T1G7	SOT23-5	5	3000	178	9	3.25	3.30	1.38	4	8	Q3
GLF2313B-T1G7	SOT23-5	5	3000	178	9	3.25	3.30	1.38	4	8	Q3
GLF2321B-T1G7	SOT23-5	5	3000	178	9	3.25	3.30	1.38	4	8	Q3

Remark:

- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- C0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P1: Pitch between successive cavity centers

High Precision Current Limit Power Switch

SPECIFICATION DEFINITIONS

Document Type	Meaning	Product Status
Target Specification	This is a target specification intended to support exploration and discussion of critical needs for a proposed or target device. Parameters including the typical, minimum, and maximum values are desired, or target. GLF reserves the right to change contents at any time without warning or notification. A target specification will not guarantee the future production of the device.	Design / Development
Preliminary Specification	This is a draft version of a product specification which is under internal review and subject to change. GLF reserves the right to change the specification at any time without warning or notification. A preliminary specification will not guarantee the future production of the device.	Qualification
Product Specification	This document represents the characteristics of the device.	Production

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